PAN1740 is the next generation Bluetooth Low Energy Module from Panasonic with reduced form factor, significantly lower power consumption and embedded Software Stack. The Single-mode Bluetooth Smart System-on-Chip module is optimized for low power, small size and low system cost products. It reduces external component count, development effort and time to market.

The Module is manufactured in a very small 9.0* 9.5* 1.8 mm3 SMD package with shielded case and chip antenna. The power consumption of only 4.9mA in Tx and Rx mode makes the use of coin cell batteries possible or reduces the needed battery capacity and cost of existing solution by at least 50%. It is qualified according to Bluetooth 4.0 standard. FCC, IC and CE approvals are under preparation.

The PAN1740 comes with a complete software development platform, which includes a qualified Bluetooth Smart single-mode stack on chip. Multiple Bluetooth Smart profiles for consumer wellness, sport, fitness, security and proximity applications are supplied as standard, while additional customer profiles can be developed and added as needed.

**OUTLINES**

PAN1740

**FEATURES**

**General**
- Single-mode Bluetooth Smart System-on-Chip
- ARM CORTEX M0 CPU
- Small 9.0 x 9.5 x 1.8 mm SMD package with antenna
- Includes 16MHz and 32.768kHz crystal
- Temperature Range from -40°C to +85°C
- Power consumption 4.9mA Rx and Tx
- Link budget 93dBm (Rx Sensitivity -93, Tx 0 dBm)

**Interfaces**
- GPIO, UART, SPI, I²C, 3-axis QD, ADC

Design and Specifications are subject to change without notice. Ask the factory for technical specifications before purchase and/or use. If there is any doubt regarding the safety of this product, kindly inform us immediately for technical consultation. The Bluetooth word mark and logos are owned by the Bluetooth SIG, Inc.
**APPLICATIONS**
- Wearable Devices
- Health Care, Medical Diagnostic Systems
- Sports and Leisure Equipment
- Mobile phone accessories
- Industrial Measurement and Diagnosis
- Devices with critical Power Consumption

**Memory**
- 42k SRAM
- 32k OTP Memory for Profiles and Apps (delivered blank)
- 84k ROM for LE Host and Boot ROM

OTP (One Time Programmable). The PAN1740 is programmed on the customer’s production line. Optional pre-programming available for higher volume. Apps and Profiles are copied from OTP, during start up, and executed in SRAM.

**BLOCK DIAGRAM**

**TECHNICAL CHARACTERISTICS**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>0,1% BER</th>
<th>Value</th>
<th>Condition / Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>Receiver Sensitivity (1% PER)</td>
<td></td>
<td>-93 dBm</td>
<td>BER 1%</td>
</tr>
<tr>
<td>Output Power</td>
<td></td>
<td>0 dBm</td>
<td>Maximum setting</td>
</tr>
<tr>
<td>Power Supply</td>
<td></td>
<td>2.35 to 3.3 V</td>
<td>Single operation voltage</td>
</tr>
<tr>
<td>Transmit Mode</td>
<td></td>
<td>4.9 mA</td>
<td>GFSK</td>
</tr>
<tr>
<td>Receive Mode</td>
<td></td>
<td>4.9 mA</td>
<td>GFSK</td>
</tr>
<tr>
<td>Operating Temperature Range</td>
<td></td>
<td>-40°C / +85°C</td>
<td>Industrial Range</td>
</tr>
</tbody>
</table>

Hardware Status:
Pre-Production